



FSA66

Low-Voltage UHS Single SPST Normally Open Analog Switch

Features

- Space-saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- Broad V_{CC} operating range: 1.65V–5.5V
- Rail-to-rail signal handling
- 5Ω switch connection between two ports
- Minimal propagation delay through the switch
- Low I_{CC}
- Zero bounce in flow-through mode
- Control input compatible with CMOS input levels
- >250 MHz –3dB bandwidth

General Description

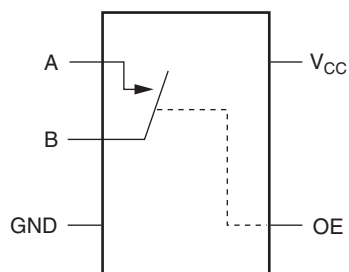
The FSA66 is a ultra high-speed (UHS) CMOS compatible Single-Pole/Single-Throw (SPST) analog switch. The low On Resistance (R_{ON}) of the switch allows input to be connected to output with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 1-bit switch with a switch enable (OE) signal. When OE is HIGH, the switch is on and Port A is connected to Port B. When OE is LOW, the switch is open and a high-impedance state exists between the two ports.

Ordering Information

Order Number	Package Number	PB-Free	Product Code Top Mark	Package Description	Packing Method
FSA66M5X	MA05B	Yes	7Z66	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
FSA66P5X	MAA05A	Yes	Z66	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
FSA66L6X	MAC06	Yes	EE	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

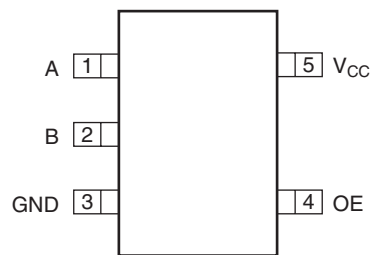
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Analog Symbol



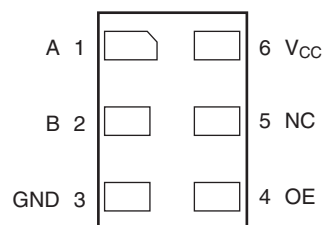
Connection Diagrams

Pin Assignments for SC70



(Top View)

Pin Assignments for MicroPak



(Top Through View)

Pin Descriptions

Pin Names	Function
OE	Switch Enable Input
A	Bus A I/O
B	Bus B I/O
NC	No Connect

Function Table

OE	B ₀	Function
L	High-Z State	Disconnect
H	A ₀	Connect

Absolute Maximum Ratings

The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The “Recommended Operating Conditions” table defines the conditions for actual device operation.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	–0.5V to +7.0V
V_S	DC Switch Voltage	–0.5V to $V_{CC} + 0.5V$
V_{IN}	DC Input Voltage ⁽¹⁾	–0.5V to +7.0V
I_{IK}	DC Input Diode Current, $V_{IN} < 0V$	–50mA
I_{OUT}	DC Output Sink Current	128mA
I_{CC}/I_{GND}	DC V_{CC}/GND Current	±100mA
T_{STG}	Storage Temperature Range	–65°C to +150°C
T_J	Junction Lead Temperature under Bias	+150°C
T_L	Junction Lead Temperature (soldering, 10 seconds)	+260°C
P_D	Power Dissipation @ 85°C SOT23-5 SC70-5	200mW 150mW

Recommended Operating Conditions⁽²⁾

Symbol	Parameter	Rating
V_{CC}	Power Supply Operating	1.65V to 5.5V
V_{IN}	Control Input Voltage	0V to 5.5V
V_{IN}	Switch Input Voltage	0V to V_{CC}
V_{OUT}	Switch Output Voltage	0V to V_{CC}
t_r, t_f	Input Rise and Fall Time Control Input; $V_{CC} = 2.3V$ to 3.6V Control Input; $V_{CC} = 4.5V$ to 5.5V Switch I/O	0ns/V to 10ns 0ns/V to 5ns 0ns/V to DC
T_A	Operating Temperature	–40°C to +85°C
θ_{JA}	Thermal Resistance SOT23-5 SC70-5	300°C/W 425°C/W

Notes:

1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.
2. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	Conditions	V _{CC} (V)	T _A =25°C			T _A = -40°C to +85°C			Units
				Min.	Typ.	Max.	Min.	Typ. ⁽⁴⁾	Max.	
V _{IH}	HiGH-Level Input Voltage		1.65 to 1.95	–	–	–	0.75 V _{CC}	–	–	V
			2.3 to 5.5	–	–	–	0.7 V _{CC}	–	–	
V _{IL}	LOW-Level Input Voltage		1.65 to 1.95	–	–	–	–	–	0.25 V _{CC}	V
			2.3 to 5.5	–	–	–	–	–	0.3 V _{CC}	
I _{IN}	Control Input Leakage Current	0 ≤ V _{IN} 5.5V	0 to 5.5	–	–	–	–	±0.05	±1.0	μA
I _{OFF}	OFF Leakage Current	0 ≤ A, B ≤ V _{CC}	1.65 to 5.5	–	–	–	–	±0.05	±10.0	μA
R _{ON}	Switch ON Resistance ⁽³⁾	V _{IN} = 0V, I _{IN} = 30mA	4.5	–	–	–	–	3	7	Ω
		V _{IN} = 2.4V, I _{IN} = 15mA		–	–	–	–	5	12	
		V _{IN} = 4.5V, I _{IN} = 30mA		–	–	–	–	7	15	
		V _{IN} = 0V, I _{IN} = 24mA	3.0	–	–	–	–	4	9	
		V _{IN} = 3V, I _{IN} = 24mA		–	–	–	–	10	20	
		V _{IN} = 0V, I _{IN} = 8mA	2.3	–	–	–	–	5	12	
		V _{IN} = 2.3V, I _{IN} = 8mA		–	–	–	–	13	30	
		V _{IN} = 0V, I _{IN} = 4mA	1.8	–	–	–	–	7	28	
		V _{IN} = 1.8V, I _{IN} = 4mA		–	–	–	–	25	60	
R _{flat}	On Resistance Flatness ⁽³⁾⁽⁵⁾⁽⁶⁾	I _A = –30mA, 0 ≤ V _{Bn} ≤ V _{CC}	5.0	–	6	–	–	–	–	Ω
		I _A = –24mA, 0 ≤ V _{Bn} ≤ V _{CC}	3.3	–	12	–	–	–	–	
		I _A = –8mA, 0 ≤ V _B ≤ V _{CC}	2.5	–	28	–	–	–	–	
		I _A = –4mA, 0 ≤ V _{Bn} ≤ V _{CC}	1.8	–	125	–	–	–	–	
I _{CC}	Quiescent Supply Current	V _{IN} = V _{CC} or GND I _{OUT} = 0V	1.65 to 5.5	–	–	–	–	0.05	10	μA

Notes:

- Measured by the voltage drop between A and B pins at the indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (A or B) pins.
- All typical values are at the specified V_{CC}, and T_A = 25°C.
- Parameter is characterized, but not tested in production.
- Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.

AC Electrical Characteristics

All typical values are @ 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = -40°C to +85°C, C _L = 50pF, R _U = R _D = 500Ω			Units	Figure Number
				Min.	Typ. ⁽⁷⁾	Max.		
t _{PHL} , t _{PLH}	Propagation Delay Bus to Bus ⁽⁸⁾	V _{IN} = OPEN	1.65 to 1.95	–	–	4.3	ns	Figure 1 Figure 2
			2.3 to 2.7	–	–	1.2		
			3.0 to 3.6	–	–	0.8		
			4.5 to 5.5	–	–	0.3		
t _{PZL} , t _{PZH}	Output Enable Time	V _{IN} = 2 x V _{CC} for t _{PZL} V _{IN} = 0V for t _{PZH}	1.65 to 1.95	1.5	7.0	14.2	ns	Figure 1 Figure 2
			2.3 to 2.7	1.5	3.3	7.0		
			3.0 to 3.6	1.5	2.4	5.5		
			4.5 to 5.5	1.5	2.0	4.5		
t _{PLZ} , t _{PHZ}	Output Disable Time	V _{IN} = 2 x V _{CC} for t _{PLZ} V _{IN} = 0V for t _{PHZ}	1.65 to 1.95	1.5	9.2	18.2	ns	Figure 1 Figure 2
			2.3 to 2.7	1.5	5.3	9.0		
			3.0 to 3.6	1.5	4.0	7.0		
			4.5 to 5.5	1.5	2.7	5.0		
Q	Charge Injection ⁽⁹⁾	C _L = 0.1nF, V _{GEN} = 0V, R _{GEN} = 0Ω, f = 1MHz	1.65 to 5.5	0.05			pC	Figure 3
OIRR	Off Isolation ⁽¹⁰⁾	R _L = 50Ω, C _L = 5pF, f = 10MHz	1.65 to 5.5	–50			dB	Figure 4
BW	-3db Bandwidth	R _L = 50Ω	1.65 to 5.5	>250			MHz	Figure 5
THD	Total Harmonic Distortion ⁽⁷⁾	R _L = 600Ω, 0.5V _{P-P} , f = 600Hz to 20KHz	5	.011			%	

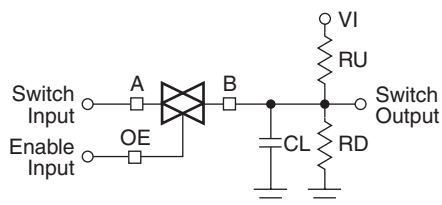
Capacitance

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
C _{IN}	Control Pin Input Capacitance	V _{CC} = 0V	–	2	–	pF
C _{I/O}	Input/Output Capacitance	V _{CC} = 5.0V	–	6	–	pF

Notes:

- All typical values are at the specified V_{CC} and T_A = 25°C.
- This parameter is guaranteed by design, but is not tested. The switch contributes no propagation delay other than the RC delay of the typical ON Resistance of the switch and the 50 pF load capacitance when driven by an ideal voltage source (zero output impedance).
- Guaranteed by design.
- Off Isolation = 20 log₁₀ [V_A/V_{BN}].

AC Loading and Waveforms



Input driven by 50Ω source terminated in 50Ω .

C_L includes load and stray capacitance.

Input PRR = 1.0MHz; $t_w = 500\text{ns}$.

Figure 1. AC Test Circuit

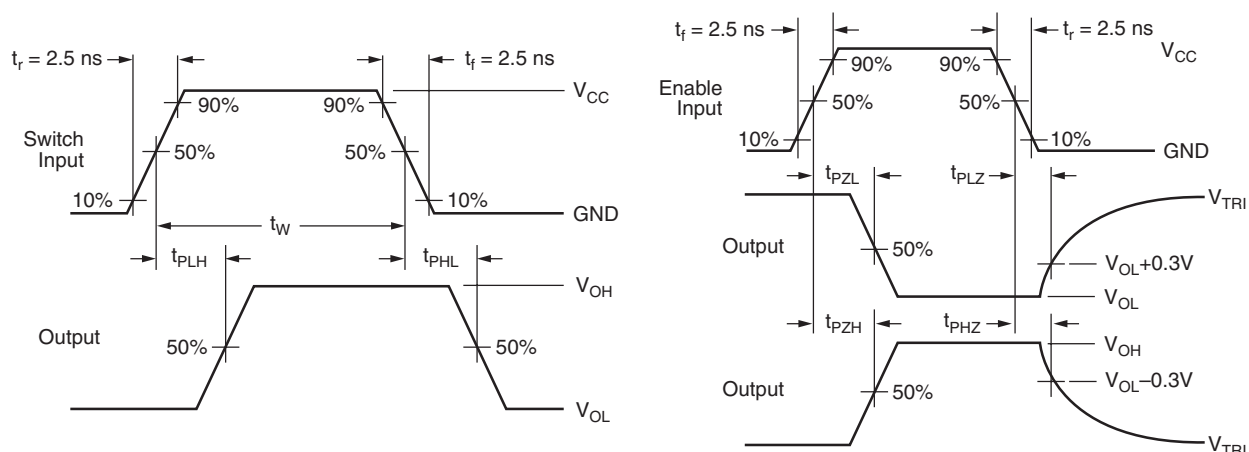


Figure 2. AC Waveforms

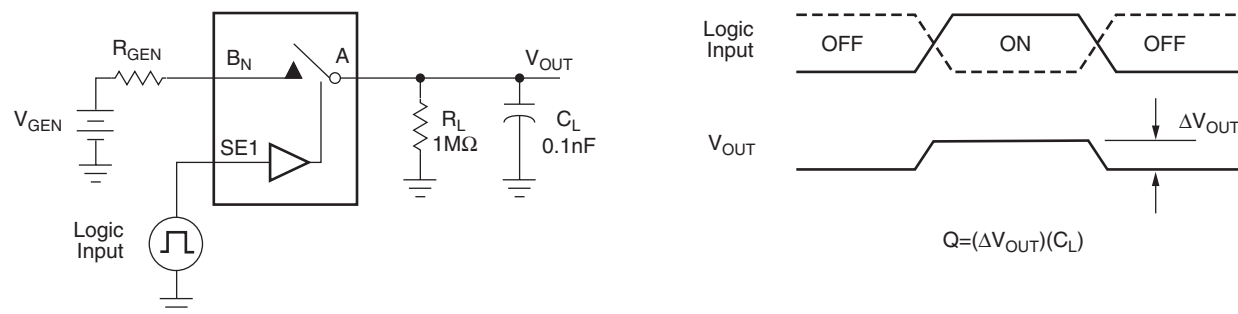


Figure 3. Charge Injection Test

AC Loading and Waveforms (Continued)

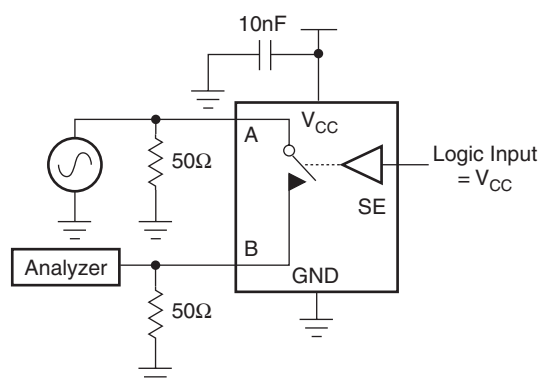


Figure 4. Off Isolation

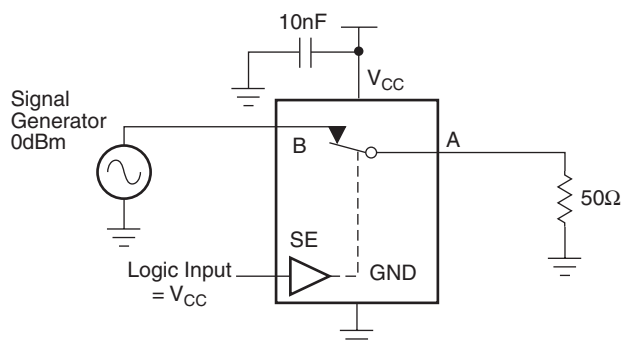


Figure 5. Bandwidth

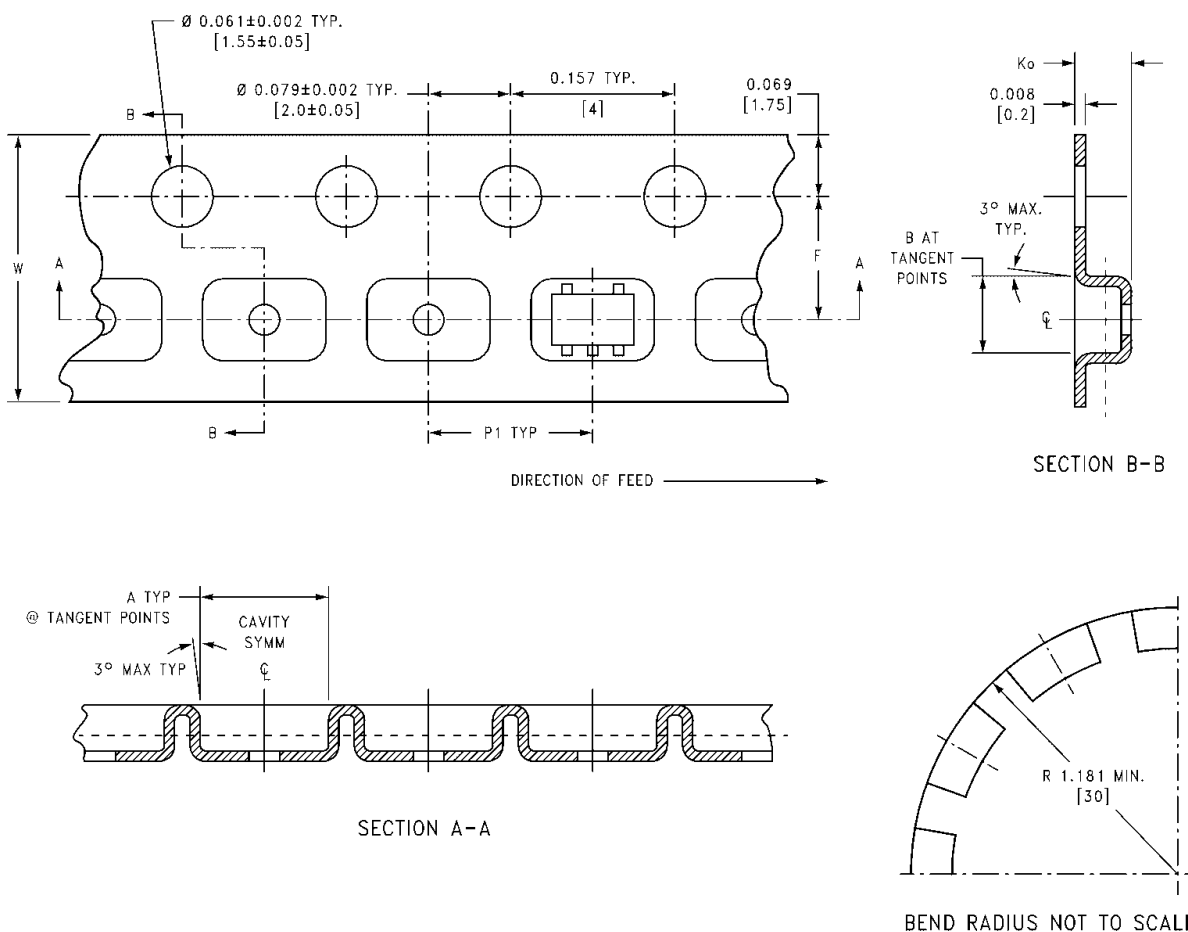
Tape Specification

Tape Format for SOT23, SC70

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Tape Status
M5X, P5X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

Tape Dimensions

Dimensions are in millimeters (inches) unless otherwise specified.



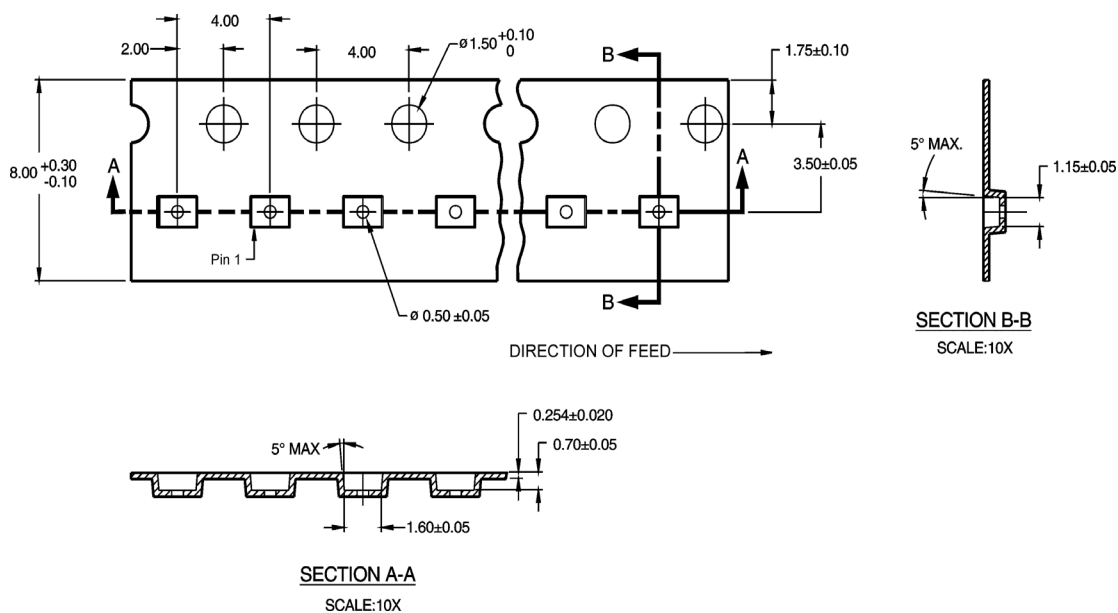
Package	Tape Size	Dim A	Dim B	Dim F	Dim K_0	Dim P1	Dim W
SC70-5	8 mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)
SOT23-5	8 mm	0.130 (3.3)	0.130 (3.3)	0.138 ± 0.002 (3.5 ± 0.05)	0.055 ± 0.004 (1.4 ± 0.11)	0.157 (4)	0.315 ± 0.012 (8 ± 0.3)

Tape Specification (Continued)**Tape Format**

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Tape Status
L6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

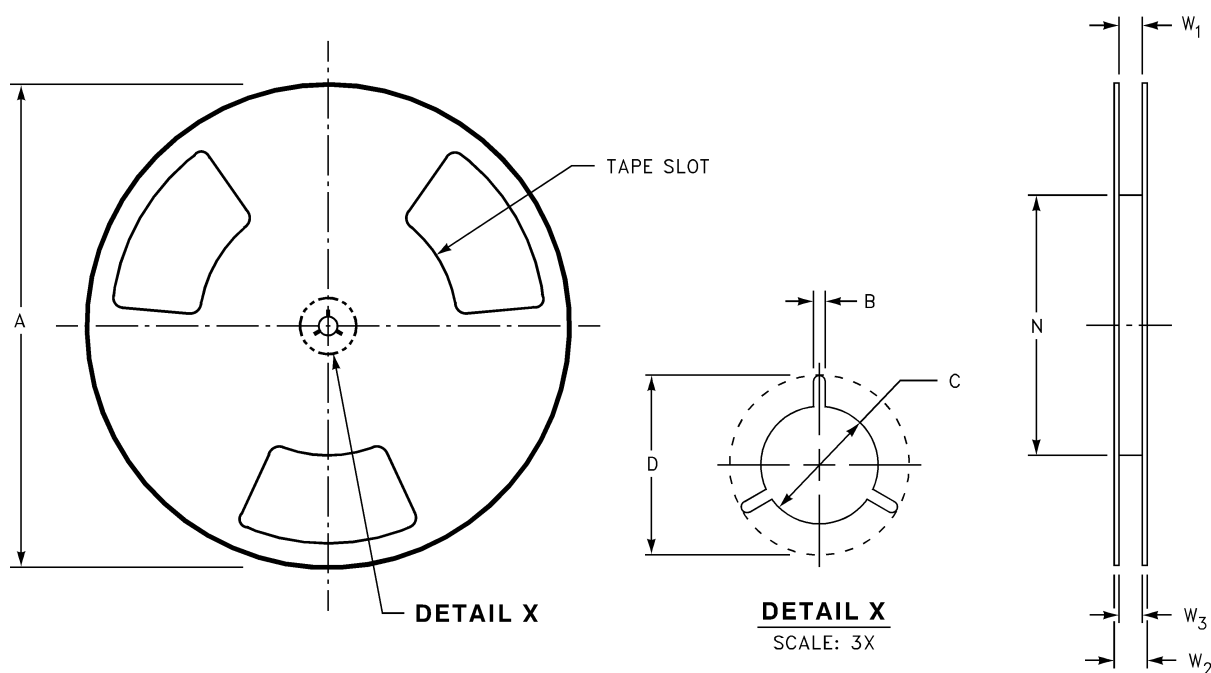
Tape Dimensions

Dimensions are in millimeters (inches) unless otherwise specified.



Reel Dimensions for Micropack 6

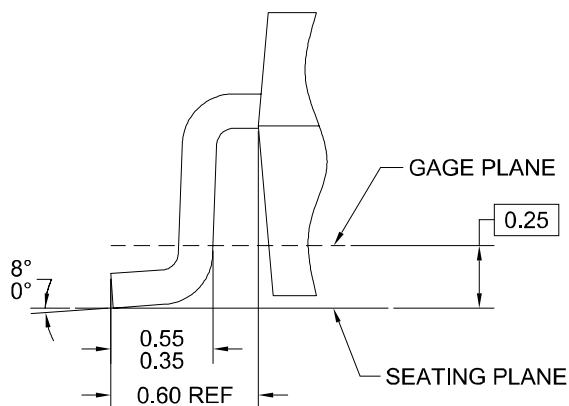
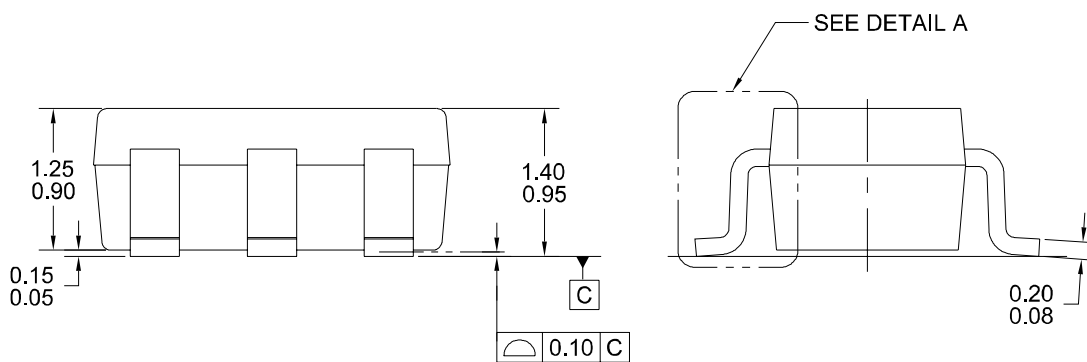
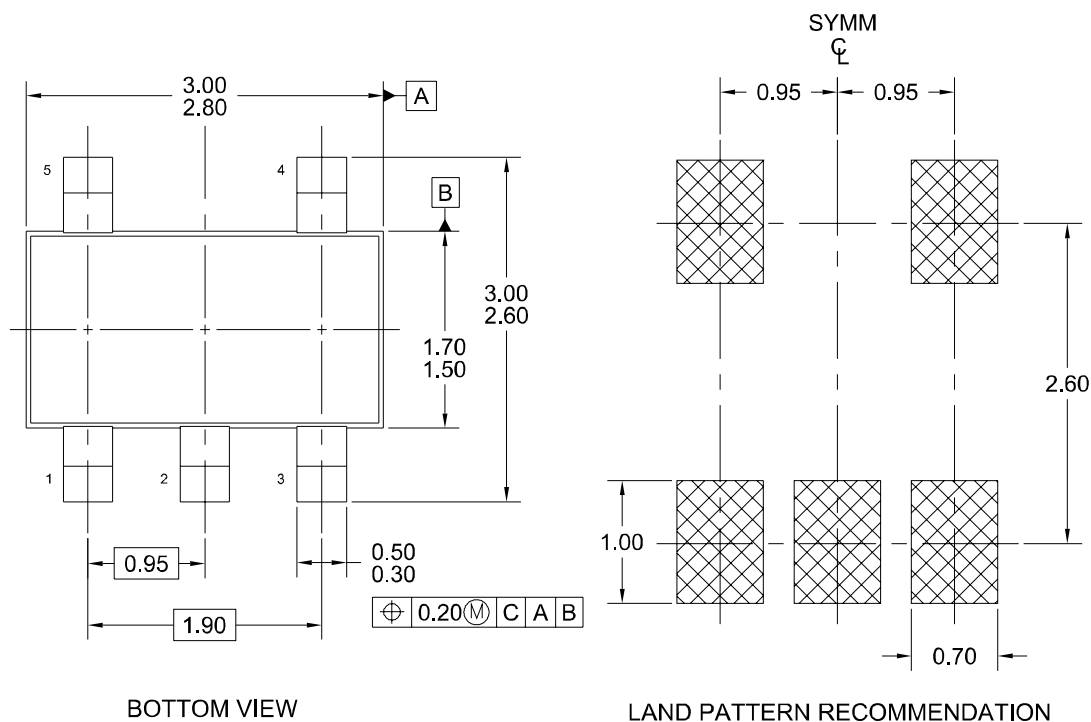
Dimensions are in millimeters (inches) unless otherwise specified.



Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 +0.059 / -0.000 (8.40 +1.50 / -0.00)	0.567 (14.40)	W1 +0.078 / -0.039 (W1 +2.00 / -1.00)

Physical Dimensions

Dimensions are in inches (millimeters) unless otherwise noted.



NOTES: UNLESS OTHERWISE SPECIFIED

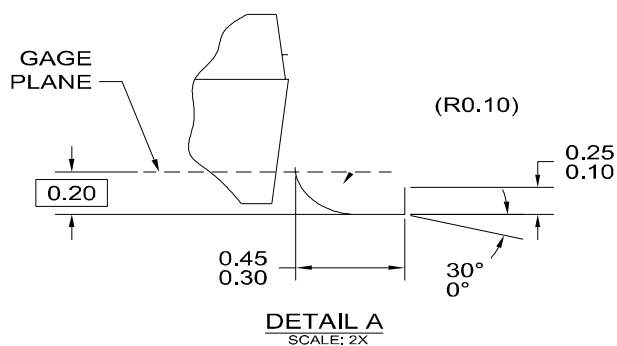
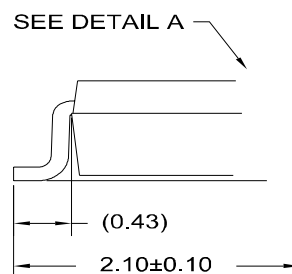
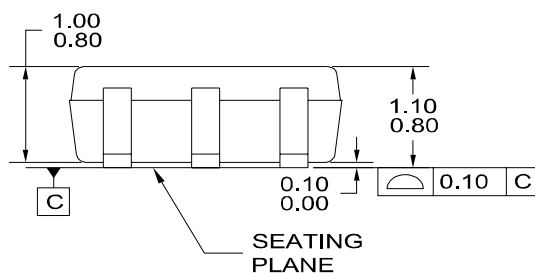
- A) THIS PACKAGE CONFORMS TO JEDEC MO-178, ISSUE B, VARIATION AA, DATED JANUARY 1999.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.

MA05BrevC

5-Lead SOT23, JEDEC MO-178, 1.6mm

Technical drawing of a rectangular plate with the following dimensions and features:

- Overall width: 2.00 ± 0.20
- Overall height: 1.25 ± 0.10
- Four mounting holes, numbered 1, 2, 3, and 4.
- Dimension lines and arrows indicating various measurements:
 - Horizontal distance from the left edge to the center of hole 1: 0.25
 - Horizontal distance between the centers of holes 1 and 2: 0.65
 - Horizontal distance between the centers of holes 2 and 3: 1.30
 - Horizontal distance from the center of hole 3 to the right edge: 0.30
 - Horizontal distance from the center of hole 3 to the right edge (alternative measurement): 0.15
 - Vertical distance from the top edge to the center of hole 4: 0.10
 - Feature control frame at the bottom right: $\text{⌀ } 0.10 \text{ (M) A B}$

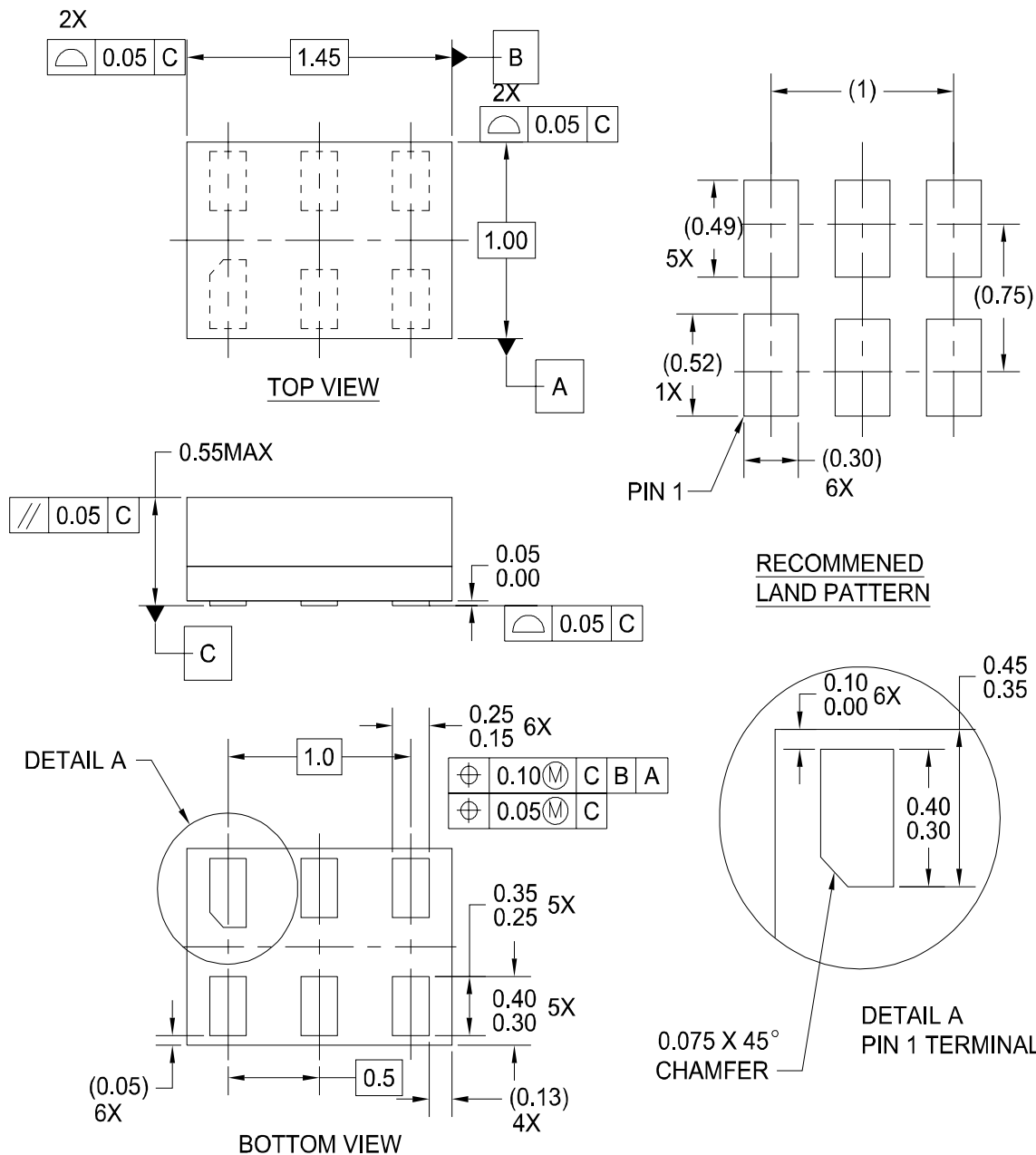


A) THIS PACKAGE CONFORMS TO EIAJ SC-88A, 1996.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide

Physical Dimensions

Dimensions are inches (millimeters) unless otherwise noted.



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06AREVC

Pb-Free 6-Lead MicroPak, 1.0mm Wide

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Build it Now™	FRFET™	MicroFET™	QFET®	SuperSOT™-8
CoolFET™	GlobalOptoisolator™	MicroPak™	QS™	SyncFET™
CROSSVOLT™	GTO™	MICROWIRE™	QT Optoelectronics™	TCM™
DOME™	HiSeC™	MSX™	Quiet Series™	TinyLogic®
EcoSPARK™	I ² C™	MSXPro™	RapidConfigure™	TINYOPTO™
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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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